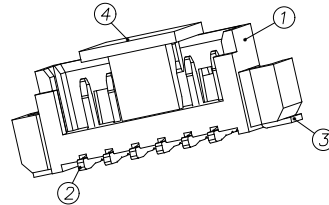
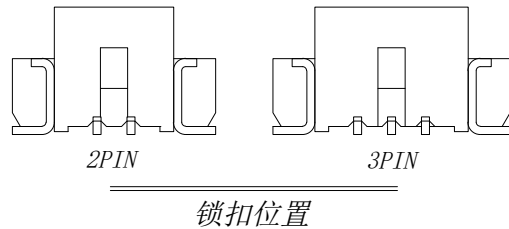
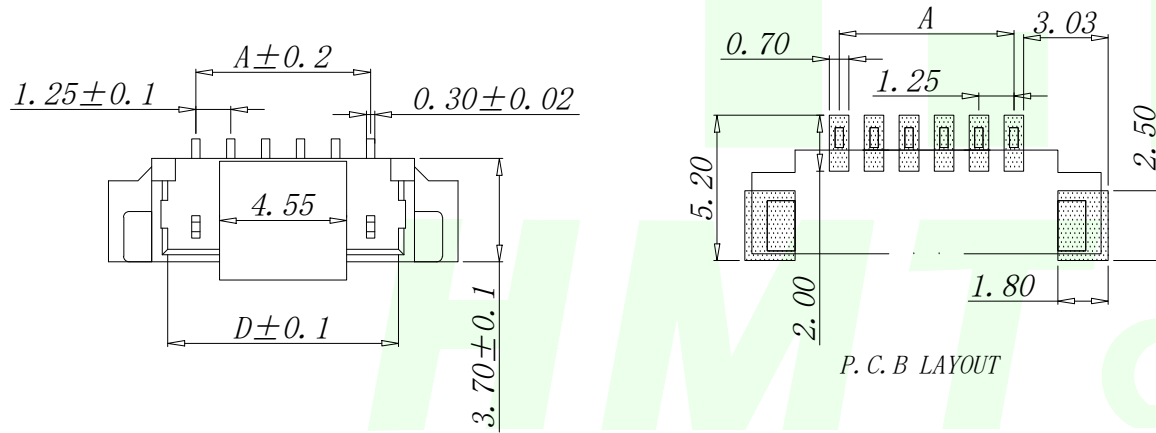
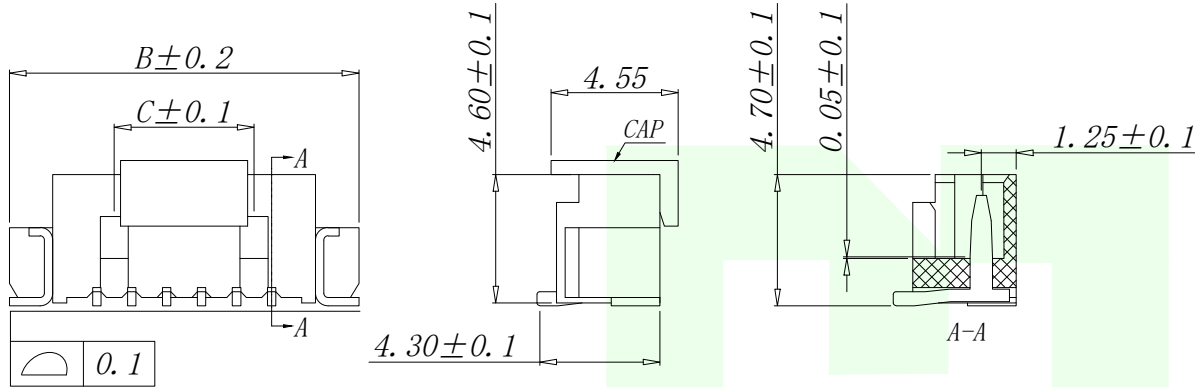


RoHs

1. 塑件表面应光洁、无毛边、无明显收缩、缺陷、裂纹等现象。
2. 锁扣窗口：2~3PIN为1个， ≥ 4 PIN为2个。
3. 不同PIN位吸盖加入/取出力有差异，实属正常现象。

VER	MARK	PR. BY	DESCRIPTION	DATE



PIN number variable size comparison table					
PART NO	PIN	A	B	C	D
HMT-MX1.25-LT2P	2	1.25	7.50		3.25
HMT-MX1.25-LT3P	3	2.50	8.75		4.50
HMT-MX1.25-LT4P	4	3.75	10.00	2.50	5.75
HMT-MX1.25-LT5P	5	5.00	11.25	3.75	7.00
HMT-MX1.25-LT6P	6	6.25	12.50	5.00	8.25
HMT-MX1.25-LT7P	7	7.50	13.75	6.25	9.50
.....					
HMT-MX1.25-LT16P	16	18.75	25.00	17.50	20.75

NOTES:

1. BASE: LCP
2. PIN: Brass
3. Solder Tab: Brass

SPECIFICATIONS:

1. Spacing: 1.25
2. Voltage Rating: 125V AC DC
3. Current Rating: 1A AC DC
4. Insulation Resistance: 100M Ω Min
5. Contact Resistance: 20m Ω Max
6. Withstanding voltage: 500V AC 1/Minute
7. Temperatuer Range: -25 $^{\circ}$ C ~+ 85 $^{\circ}$ C

GENERAL TOLERANCES UNLESS SPECIFIED		深圳市华明通电子有限公司 HMTCONN Shenzhen Huamingtong Electronics Co., Ltd			
X.X ± 0.30	X. $^{\circ}$ $\pm 5^{\circ}$	PART NO. HMT-MX1.25-LTNP	TITLE: WAFER 1.25 立贴		
.XX ± 0.20	X.X $^{\circ}$ $\pm 1^{\circ}$				
.XXX ± 0.10	X.XX $^{\circ}$ $\pm 0.5^{\circ}$	DESIGN: James	CUSTOMER	SIZE	UNITS
MANUFACTURE DWG		CHED: Talen		A4	MM
		APPD: Sophia		SCALE	SHEET
				N:A	1/1